FAIRCHILD
SEMICONDUCTOR™

January 2000
Revised February 2000

GTLP17T616
17-Bit LVTTL/GTLP Bus Transceiver with Buffered Clock

General Description

The GTLP17T616 is a 17-bit registered bus transceiver that provides LVTTL to GTLP signal level translation. It allows for transparent, latched and clocked modes of data flow and provides a buffered GTLP (CLKOUT) clock output from the LVTTL CLKAB. The device provides a high speed interface between cards operating at LVTTL logic levels and a backplane operating at GTLP logic levels. High speed backplane operation is a direct result of GTLP's reduced output swing (<1V), reduced input threshold levels and output edge rate control. The edge rate control minimizes bus settling time. GTLP is a Fairchild Semiconductor derivative of the Gunning Transistor logic (GTL) JEDEC standard JESD8-3.

Fairchild's GTLP has internal edge-rate control and is Process, Voltage, and Temperature (PVT) compensated. Its function is similar to BTL or GTL but with different output levels and receiver thresholds. GTLP output LOW level is typically less than 0.5V, the output level HIGH is 1.5V and the receiver threshold is 1.0V.

Features

- Bidirectional interface between GTLP and LVTTL logic levels
- Edge Rate Control to minimize noise on the GTLP port
- Power up/down high impedance for live insertion
- External V_{REF} pin for receiver threshold adjustability
- BiCMOS technology for low power dissipation
- Bushold data inputs on A Port eliminates the need for external pull-up resistors for unused inputs
- LVTTL compatible Driver and Control inputs
- Flow-through architecture optimizes PCB layout
- Open drain on GTLP to support wired-or connection
- A Port source/sink −24 mA/+24 mA
- B Port sink capability +50 mA
- D-type flip-flop, latch and transparent data paths
- GTLP Buffered CLKAB signal available (CLKOUT)
- −40°C to +85°C Temperature operation

Ordering Code:

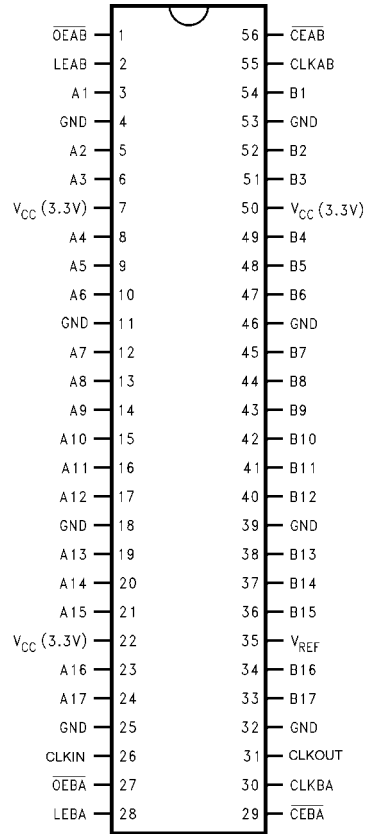| Order Number	Package Number	Package Description
GTLP17T616MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
GTLP17T616MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

GTLP17T616

Pin Descriptions

Pin Names	Description
OEAB	A-to-B Output Enable (Active LOW) (LVTTL levels)
OEBA	B-to-A Output Enable (Active LOW) (LVTTL levels)
CEAB	A-to-B Clock/LE Enable (Active LOW) (LVTTL levels)
CEBA	B-to-A Clock/LE Enable (Active LOW) (LVTTL levels)
LEAB	A-to-B Latch Enable (Transparent HIGH) (LVTTL levels)
LEBA	B-to-A Latch Enable (Transparent HIGH) (LVTTL levels)
V_{REF}	GTLP Input Threshold Reference Voltage
CLKAB	A-to-B Clock (LVTTL levels)
CLKBA	B-to-A Clock (LVTTL levels)
A1–A17	A-to-B Data Inputs or B-to-A 3-STATE Outputs
B1–B17	B-to-A Data Inputs or A-to-B Open Drain Outputs (GTLP Levels)
CLKIN	B-to-A Buffered Clock Output (LVTTL levels)
CLKOUT	GTLP Buffered Clock Input/Output of CLKAB (GTLP Levels)

Connection Diagram

Left	Pin	Pin	Right
OEAB	1	56	CEAB
LEAB	2	55	CLKAB
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
V_{CC} (3.3V)	7	50	V_{CC} (3.3V)
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
V_{CC} (3.3V)	22	35	V_{REF}
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
CLKIN	26	31	CLKOUT
OEBA	27	30	CLKBA
LEBA	28	29	CEBA

Truth Table (Note 1)

CEAB	OEAB	LEAB	CLKAB	A	Output B	Mode
X	H	X	X	X	Z	Latched storage of A data
L	L	L	H or L	X	B_0 (Note 2)	
L	L	L	H or L	X	B_0 (Note 3)	
X	L	H	X	L	L	Transparent
X	L	H	X	H	H	
L	L	L	↑	L	L	Clocked storage of A data
L	L	L	↑	H	H	
H	L	L	X	X	B_0 (Note 3)	Clock inhibit

**Note 1:** A-to-B data flow is shown. B-to-A data flow is similar but uses OEBA, LEBA, CLKBA, and CEBA.
Note 2: Output level before the indicated steady state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.
Note 3: Output level before the indicated steady-state input conditions were established.

Functional Description

The GTLP17T616 is a 17 bit registered transceiver containing D-type flip-flop, latch and transparent modes of operation for the data path and a GTLP translation of the CLKAB signal (CLKOUT). Data flow in each direction is controlled by the clock enables (CEAB and CEBA), latch enables (LEAB and LEBA), clock (CLKAB and CLKBA) and output enables (OEAB and OEBA). The clock enables (CEAB and CEBA) enable all 17 bits. The output enables (OEAB and OEBA) control the 17 bits of data and the CLKOUT/CLKIN buffered clock path. For A-to-B data flow, when CEAB is low, the device operates on the LOW-to-HIGH transition of CLKAB for the flip-flop and on the HIGH-to-LOW transition of LEAB for the latch path. That is, if CEAB is LOW and LEAB is LOW the A data is latched regardless as to the state of CLKAB (HIGH or LOW) and if LEAB is HIGH the device is in transparent mode. When OEAB is LOW the outputs are active. When OEAB is HIGH the outputs are high impedance. The data flow of B-to-A is similar except that CEAB, OEBA, LEBA and CLKBA are used.

Logic Diagram
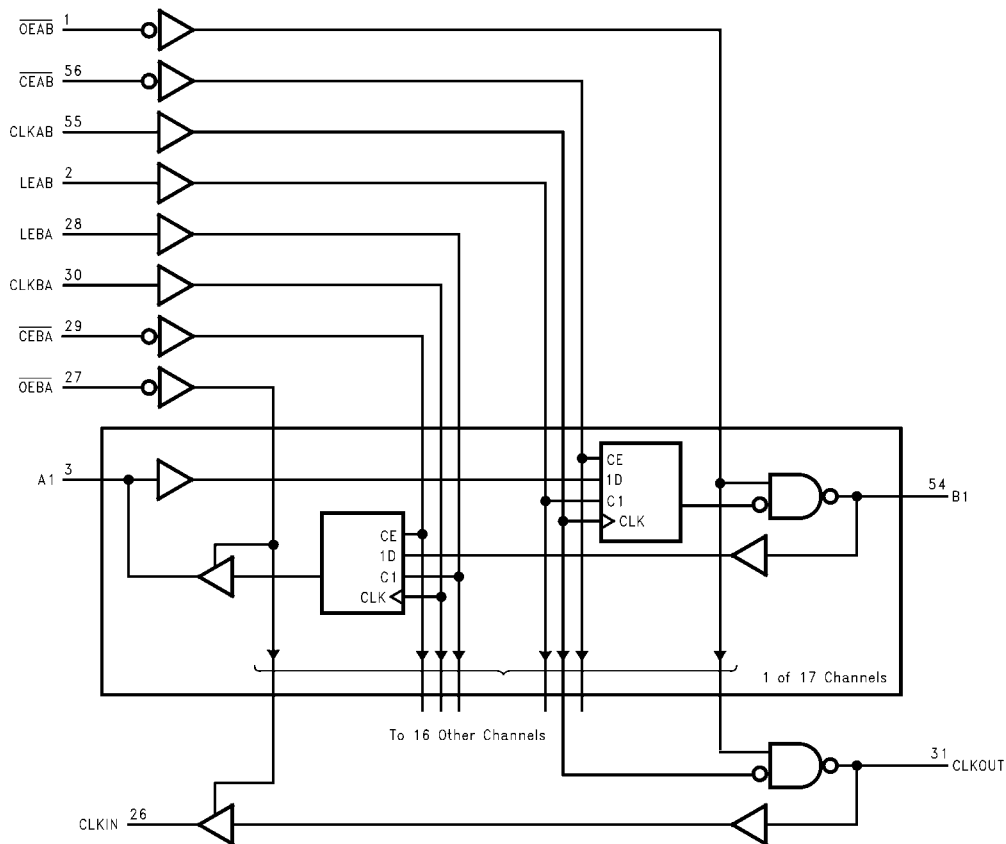
Absolute Maximum Ratings(Note 4)

Supply Voltage (V_{CC})	−0.5V to +4.6V
DC Input Voltage (V_I)	−0.5V to +4.6V
DC Output Voltage (V_O)	
Outputs 3-STATE	−0.5V to +4.6V
Outputs Active (Note 5)	−0.5V to +4.6V
DC Output Sink Current into	
A Port I_{OL}	48 mA
DC Output Source Current from	
A Port I_{OH}	−48 mA
DC Output Sink Current into	
B Port in the LOW State, I_{OL}	100 mA
DC Input Diode Current (I_{IK})	
$V_I < 0V$	−50 mA
DC Output Diode Current (I_{OK})	
$V_O < 0V$	−50 mA
ESD Rating	>2000V
Storage Temperature (T_{STG})	−65°C to +150°C

Recommended Operating Conditions

Supply Voltage V_{CC}/V_{CCQ}	3.15V to 3.45V
Bus Termination Voltage (V_{TT})	
GTLP	1.47V to 1.53V
V_{REF}	0.98V to 1.02V
Input Voltage (V_I)	
on A Port and Control Pins	0.0V to V_{CC}
on B Port	0.0V to V_{CC}
HIGH Level Output Current (I_{OH})	
A Port	−24 mA
LOW Level Output Current (I_{OL})	
A Port	+24 mA
B Port	+50 mA
Operating Temperature (T_A)	−40°C to +85°C

Note 4: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions in not implied.

Note 5: I_O Absolute Maximum Rating must be observed.

DC Electrical Characteristics

Over Recommended Operating Free-Air Temperature Range, V_{REF} = 1.0V (unless otherwise noted).

Symbol		Test Conditions		Min	Typ (Note 6)	Max	Units
V_{IH}	B Port			V_{REF} + 0.05		V_{TT}	V
	Others			2.0			
V_{IL}	B Port			0.0		V_{REF} − 0.05	V
	Others					0.8	
V_{REF}	B Port	$V_{TT} > V_{REF}$ + 50 mV		0.25	1.0	V_{CC} − 1.2V	V
V_{TT}	B Port	$V_{TT} > V_{REF}$ + 50 mV		V_{REF} + 50 mV	1.5	V_{CC}	
V_{IK}		V_{CC} = 3.15V	I_I = −18 mA			−1.2	V
V_{OH}	A Port	V_{CC} = Min to Max (Note 7)	I_{OH} = −100 µA	V_{CC} −0.2			V
		V_{CC} = 3.15V	I_{OH} = −18 mA	2.4			
			I_{OH} = -24mA	2.2			
V_{OL}	A Port	V_{CC} = Min to Max (Note 7)	I_{OL} = 100 µA			0.2	V
		V_{CC} = 3.15V	I_{OL} = 24mA			0.5	
	B Port	V_{CC} = 3.15V	I_{OL} = 40 mA			0.4	V
			I_{OL} = 50 mA			0.55	
I_I	Control Pins	V_{CC} = Min to Max (Note 7)	V_I = 3.45V or 0V			±5	µA
	A Port	V_{CC} = 3.45V	V_I = 3.45V or 0V			±10	µA
	B Port	V_{CC} = 3.45V	V_I = 0 to 3.45V			±5	µA
$I_{PU/PD}$	All Ports	V_{CC} = 0 to 1.5V	V_I/V_O = 0 to 3.45V			±30	µA
I_{OFF}	All Ports	V_{CC} = 0	V_I or V_O = 0 to 3.45V			30	µA
$I_{I(hold)}$	A Port	V_{CC} = 3.15V	V_I = 0.8V	75			µA
			V_I = 2.0V			−75	
I_{OZH}	A Port	V_{CC} = 3.45V	V_O = 3.45V			10	µA
	B Port		V_O = 1.5V			5	
I_{OZL}	A Port	V_{CC} = 3.45V	V_O = 0V			−10	µA
	B Port		V_O = 0.55V			−5	
I_{CC} (V_{CC}/V_{CCQ})	A or B Ports	V_{CC} = 3.45V	Outputs HIGH			45	mA
		I_O = 0	Outputs LOW			45	
		$V_I = V_{CC}$ or GND	Outputs Disabled			45	
ΔI_{CC} (Note 8)	A Port and Control Pins	V_{CC} = 3.45V, A or Control Inputs at V_{CC} or GND	One Input at 2.7V		0	2	mA

DC Electrical Characteristics (Continued)

Symbol		Test Conditions		Min	Typ (Note 6)	Max	Units
C_i	Control Pins		$V_I = V_{CC}$ or 0			5.0	pF
	A Port		$V_I = V_{CC}$ or 0			7.0	
	B Port		$V_I = V_{CC}$ or 0			9.0	

Note 6: All typical values are at V_{CC} = 3.3V, V_{CCQ} = 3.3V, and T_A = 25°C.

Note 7: For conditions shown as Min or Max, use the appropriate value specified under recommended operating conditions.

Note 8: This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

AC Operating Requirements

Over recommended ranges of supply voltage and operating free-air temperature, V_{REF} = 1.0V (unless otherwise noted).

Symbol		Test Conditions	Min	Max	Unit
f_{TOGGLE}	Max Toggle Frequency	Transparent Mode	125		MHz
f_{MAX}	Max Clock Frequency	Registered Mode	125		
t_{WIDTH}	Pulse Duration	LEAB or LEBA HIGH	3.0		ns
		CLKAB or CLKBA HIGH or LOW	3.0		
t_{SU}	Setup Time	A before CLKAB↑	0.6		ns
		B before CLKBA↑	1.2		
		A before LEAB↑	0.5		
		B before LEBA↑	1.3		
		$\overline{CEAB}$ before CLKAB↑	1.4		
		$\overline{CEBA}$ before CLKBA↑	1.2		
t_{HOLD}	Hold Time	A after CLKAB↑	0		ns
		B after CLKBA↑	0.2		
		A after LEAB↑	0.2		
		B after LEBA↑	0		
		$\overline{CEAB}$ after CLKAB↑	0.5		
		$\overline{CEBA}$ after CLKBA↑	0.6		

AC Electrical Characteristics

Over recommended range of supply voltage and operating free-air temperature, V_{REF} = 1.0V (unless otherwise noted).

C_L = 30 pF for B Port and C_L = 50 pF for A Port.

Symbol	From (Input)	To (Output)	Min	Typ (Note 9)	Max	Unit
t_{PLH}	A	B	1.6	4.0	6.3	ns
t_{PHL}			1.0	2.5	4.4	
t_{PLH}	LEAB	B	1.5	3.9	6.3	ns
t_{PHL}			0.9	2.3	4.2	
t_{PLH}	CLKAB	B	1.6	4.0	6.3	ns
t_{PHL}			1.0	2.4	4.0	
t_{PLH}	CLKAB	CLKOUT	2.6	5.2	7.7	ns
t_{PHL}			1.7	3.4	6.0	
t_{PLH}	$\overline{OEAB}$	B or CLKOUT	1.1	4.3	6.5	ns
t_{PHL}			1.0	2.0	4.3	
t_{RISE}	Transition time, B outputs (20% to 80%)			2.3		ns
t_{FALL}	Transition time, B outputs (80% to 20%)			1.6		
t_{RISE}	Transition Time, A outputs (10% to 90%)			2.3		ns
t_{FALL}	Transition Time, A outputs (90% to 10%)			2.3		
t_{PLH}	B	A	1.7	2.9	4.5	ns
t_{PHL}			1.7	3.2	5.8	
t_{PLH}	LEBA	A	0.3	2.5	4.6	ns
t_{PHL}			0.4	2.5	4.6	
t_{PLH}	CLKBA	A	0.5	2.6	4.6	ns
t_{PHL}			0.6	2.8	4.6	
t_{PLH}	CLKOUT	CLKIN	1.2	2.4	5.3	ns
t_{PHL}			2.2	3.5	5.3	
t_{PZH}, t_{PZL}	$\overline{OEBA}$	A or CLKIN	0.3	2.8	5.2	ns
t_{PHZ}, t_{PLZ}			0.3	2.5	5.2	

Note 9: All typical values are at V_{CC} = 3.3V, and T_A = 25°C.

AC Extended Electrical Characteristics

Over recommended ranges of supply voltage and operating free-air temperature V_{REF} = 1.0V (unless otherwise noted).
C_L = 30 pF for B Port and C_L = 50 pF for A Port.

Symbol	From (Input)	To (Output)	Min	Typ (Note 10)	Max	Unit
t_{OSLH} (Note 11)	A	B		0.3	1.0	ns
t_{OSHL} (Note 11)				0.3	0.6	
t_{PVHL} (Note 12)(Note 13)	A	B			2.5	ns
t_{OSLH} (Note 11)	CLKAB	B		0.3	1.0	ns
t_{OSHL} (Note 11)				0.3	0.6	
t_{PVHL} (Note 12)(Note 13)	CLKAB	B			2.5	ns
t_{OSLH} (Note 11)	B	A		0.3	0.5	ns
t_{OSHL} (Note 11)				0.3	0.5	
t_{OST} (Note 11)	B	A		0.5	1.2	ns
t_{PV} (Note 12)	B	A			2.5	ns
t_{OSLH} (Note 11)	CLKBA	A		0.3	0.5	ns
t_{OSHL} (Note 11)				0.3	0.5	
t_{OST} (Note 11)	CLKBA	A		0.5	1.2	ns
t_{PV} (Note 12)	CLKBA	A			2.5	ns
t_{PVHL} (Note 11)(Note 12)	CLKAB	CLKOUT			2.8	ns
t_{PDELLH} (Note 14)	B	CLKOUT	0		1.7	ns
t_{PDELHL} (Note 14)			0		1.5	

Note 10: All typical values are at V_{CC} = 3.3V, and T_A = 25°C.

Note 11: t_{OSHL}/t_{OSLH} and t_{OST} - Output to output skew is defined as the absolute value of the difference between the actual propagation delay for all outputs within the same packaged device. The specifications are given for specific worst case V_{CC} and temperature and apply to any outputs switching in the same direction either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}) or in opposite directions both HL and LH (t_{OST}). This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device.

Note 12: t_{PV} - Part to part skew is defined as the absolute value of the difference between the actual propagation delay for all outputs from device to device. The parameter is specified for a specific worst case V_{CC} and temperature. This parameter is guaranteed by design and statistical process distribution. Actual skew values between the GTLP outputs could vary on the backplane due to the loading and impedance seen by the device.

Note 13: Due to the open drain structure on GTLP outputs t_{OST} and $t_{PV(LH)}$ in the A-to-B direction are not specified. Skew on these paths is dependent on the V_{TT} and R_T values on the backplane.

Note 14: t_{PDELLH} and t_{PDELHL} -B to CLKOUT propagation delay delta is defined as the difference between the CLKAB to CLKOUT propagation delay and the CLKAB to B propagation delays. This parameter is for a given device and is not meant to guarantee the delta between the CLKAB to CLKOUT propagation delays of one device and the CLKAB to B propagation delays of other devices. This parameter is guaranteed by design and statistical process distribution.
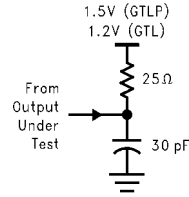
Test Circuits and Timing Waveforms

Test Circuit for A Outputs
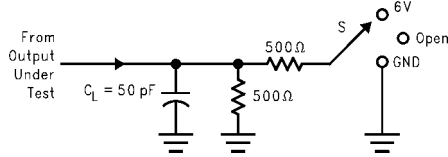
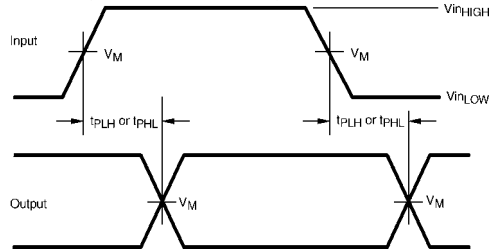| Test	S
t_{PLH}/t_{PHL}	OPEN
t_{PLZ}/t_{PZL}	6V
t_{PHZ}/t_{PZH}	GND

Note A: C_L includes probes and Jig capacitance.

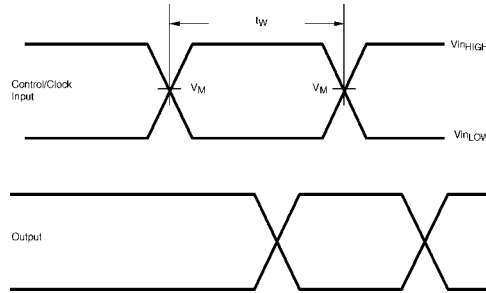### Test Circuit for B Outputs

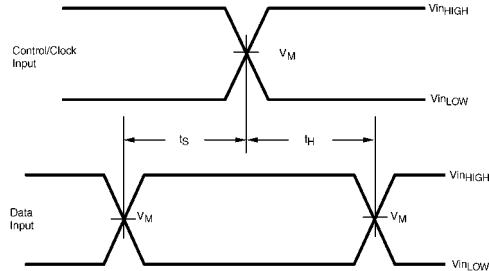**Note B:** For B Port, C_L = 30 pF is used for worst case.

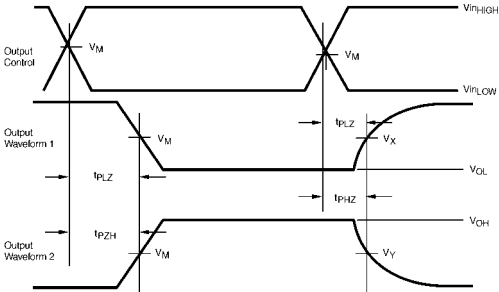### Voltage Waveform - Propagation Delay Times

Voltage Waveform - Pulse Width

Voltage Waveform - Setup and Hold Times

### Voltage Waveform Enable and Disable times

Output Waveform 1 is for an output with internal conditions such that the output is LOW except when disabled by the control output.
Output Waveform 2 is for an output with internal conditions such that the output is HIGH except when disabled by the control output.

Input and Measure Conditions

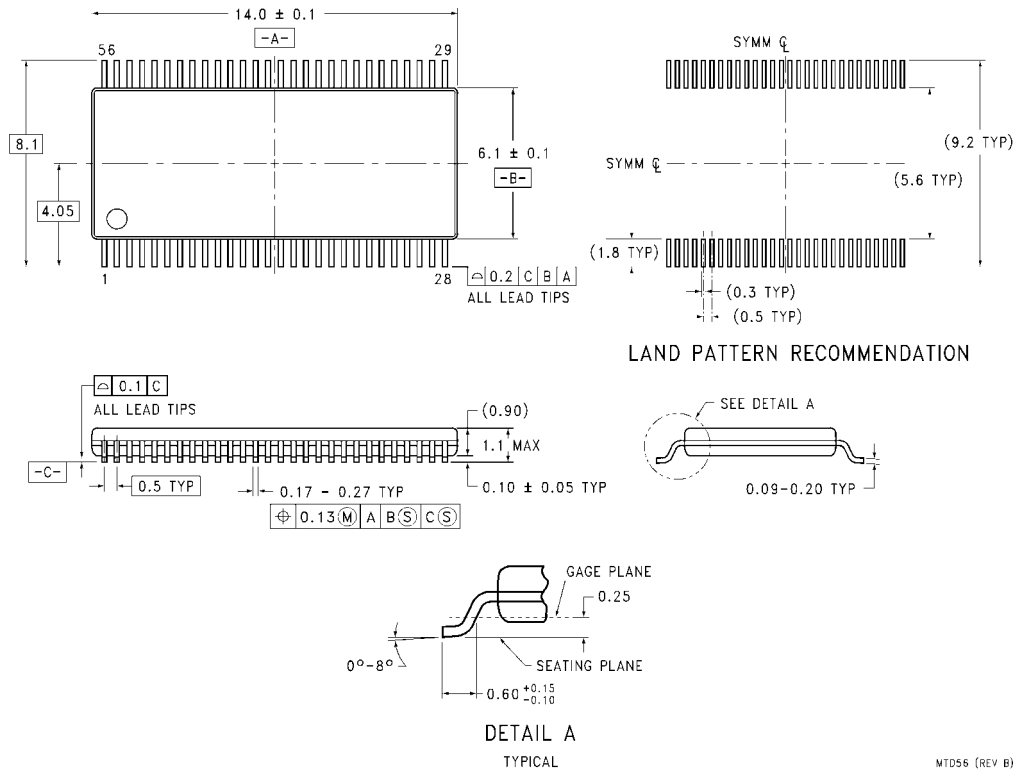|	A or LVTTL Pins	B or GTLP Pins
V_{inHIGH}	V_{CC}	1.5
V_{inLOW}	0.0	0.0
V_M	$V_{CC}/2$	1.0
V_X	$V_{OL} + 0.3V$	N/A
V_Y	$V_{OH} - 0.3V$	N/A

All input pulses have the following characteristics: Frequency = 10MHz, t_{RISE} = t_{FALL} = 2 ns (10% to 90%), Z_O = 50Ω
The outputs are measured one at a time with one transition per measurement.

Physical Dimensions inches (millimeters) unless otherwise noted
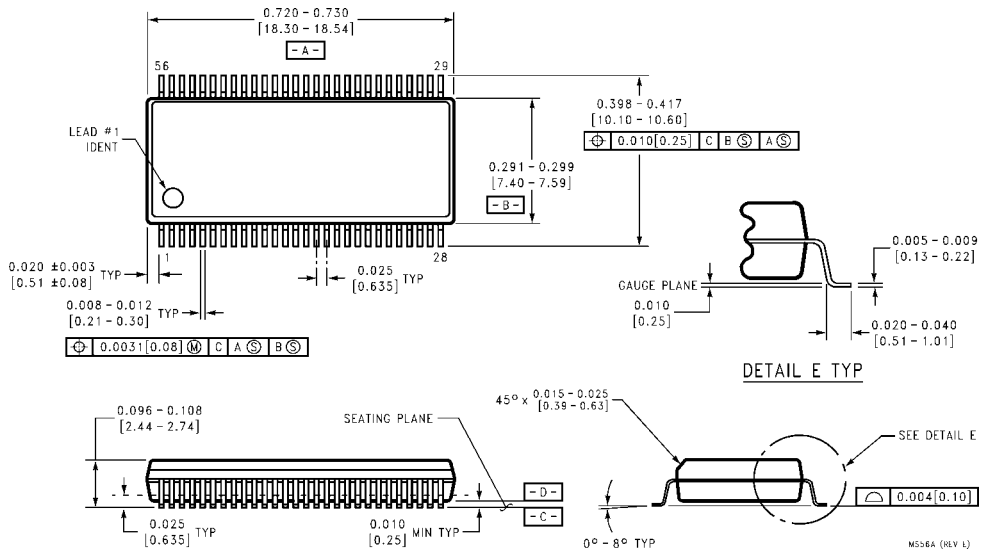
56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
Package Number MS56A

GTLP17T616 17-Bit LVTTL/GTLP Bus Transceiver with Buffered Clock

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

SYMM Ç

(9.2 TYP)

(5.6 TYP)

(1.8 TYP)

(0.3 TYP)

(0.5 TYP)

LAND PATTERN RECOMMENDATION

14.0 ± 0.1

−A−

56   29

8.1

4.05

6.1 ± 0.1

−B−

1   28

0.2 C B A
ALL LEAD TIPS

0.1 C
ALL LEAD TIPS

−C−

0.5 TYP

0.17 − 0.27 TYP

0.13 (M) A B(S) C(S)

(0.90)

1.1 MAX

0.10 ± 0.05 TYP

SEE DETAIL A

0.09−0.20 TYP

GAGE PLANE

0.25

SEATING PLANE

0° − 8°

0.60 +0.15/−0.10

DETAIL A
TYPICAL

MTD56 (REV B)

56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
Package Number MTD56

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com

www.fairchildsemi.com   10